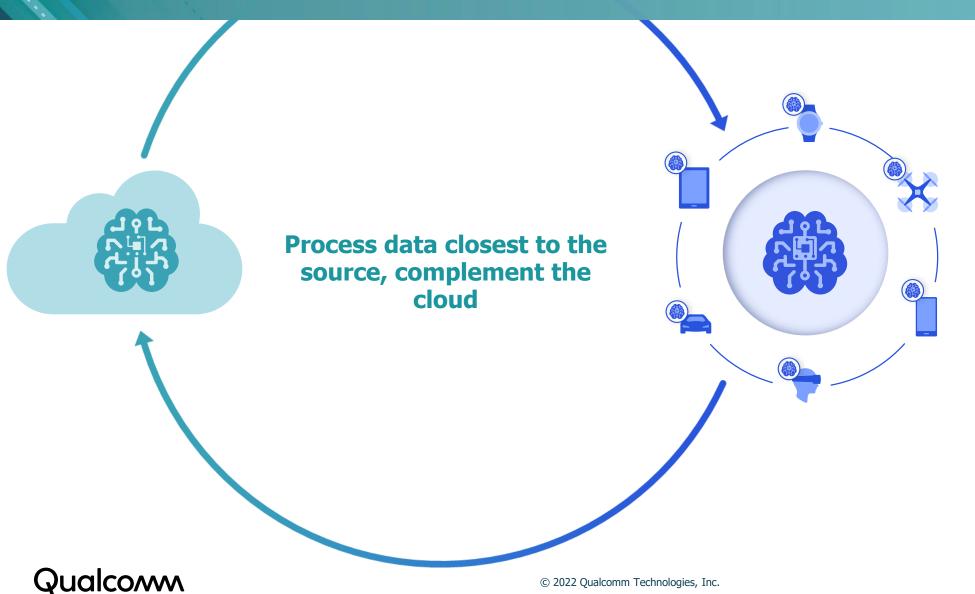


The Future of AI is Here Today: Deep Dive into Qualcomm's On-Device AI Offering

Vinesh Sukumar Sr. Director, Product Management (AI/ML) Qualcomm Technologies, Inc.

Center of Gravity Moving to the Edge...





Historically

Privacy

Reliability

Low latency

Efficient use of network bandwidth

Increased Demand

Autonomy

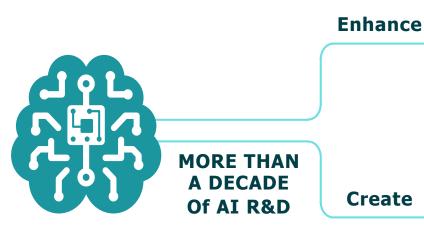
Personalization

Efficiency

Security

At Qualcomm — AI Deployed Across Various Technologies & Verticals







Superior solutions

Enabling developer ecosystems



Windows 11 – PC Computing

Devices will need a neural processing unit (NPU) to use these new Windows 11 features, which means they'll show up first on Lenovo's new ThinkPad X13s, which is powered by Qualcomm's Snapdragon 8cx Gen 3 compute platform.

Smart Camera – IoT Markets

Qualcomm debuts smart camera processor at ISC West

<u>Qualcomm</u> showcased a smart camera processor named QCS7230 at the International Security Conference and Exposition (ISC West) that expands its Vision Intelligence Platform portfolio to cities, enterprises, and public spaces.

ADAS Markets

Ferrari and Qualcomm team up for tech projects for road, racing cars



Snapdragon, Qualcomm QCS7230, and Qualcomm Al Engine are products of Qualcomm Technologies, Inc. and/or its subsidiaries.

Software layer

Hardware layer

AI Applications



AI Applications: Across Various Segments

Expanding beyond modalities of computer vision to linguistics, communication, commerce and language understanding



Mobile	IoT	Compute	Cloud	Auto
AI Assisted Imaging • AI 3A	Robotics Autonomous navigation Obstacle Avoidance Picking and Sorting	Productivity Background based noise cancellation on Audio (inbound and outbound) Segmentation/Blur/Super Resolution on Video	Data Centers	 IVI Occupancy monitoring system (OMS) Driver monitoring system (DMS)
Scene-based Camera Selection Image Understanding Face Detection / Tracking / Features Object Detection / Tracking Body Detection / Tracking / Pose Human Segmentation Sky Segmentation Multi-Class Segmentation	Retail Visitor/Face/Gesture Recognition Object/People Detection and Counting Barcode decoding Empty shelf detection Dwell time	Voice activation without keywords Face tracking Smart photo categorization	Natural language processing Computer vision Recommendation system	Surround perception Audio Command & Control
		Privacy & Security • Automatic screen unlock and login • Privacy alert • Guard mode		
Depth Estimation	Transportation			ADAS (Up to L4) Highway driving assist
Scene-based Image Enhancement • Face a • Drows:	License plate recognition Face and facial landmark detection Drowsiness detection	Content Creation & Gaming Gaming with gesture control Gaming with voice commands Intelligent highlight videos Game play improvement		Front collision warning lane departure, Traffic jam assist Auto lane change Auto lane merge Traffic light recognition
Image ProcessingAI based NR or Image SRScene-based Camera Selection	Smart Devices Object/People detection Speaker detection			
Audio	Gun shot detection		Edge Compute • Theft detection	Construction zones Urban autonomous driving
• Parameter optimization • Robust sequence predictions • Parameter optimization • Parameter optimization	Smart Buildings People Tracking Access Control	Performance & Efficiency Power and Screen optimization	Face/body/license plate detection / recognition Image classification and segmentation	Parking assist Person detection, Perception Valet parking Driver monitoring
	Manufacturing/Logistics Predictive maintenance Energy management with Asset demand			

Innovation centered around energy efficiency & personalization

Innovation centered around making
AI relevant in PC

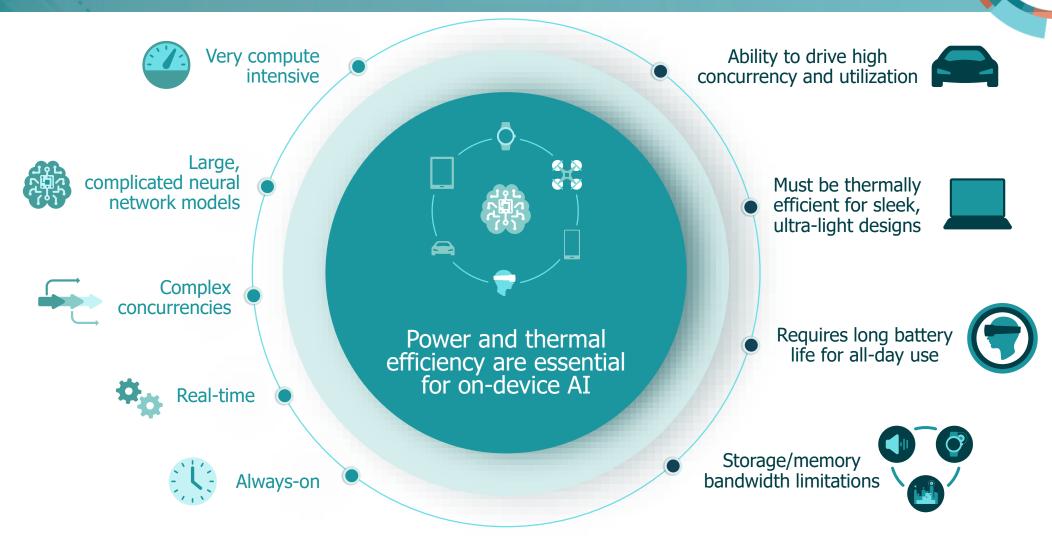
Innovation centered around supporting high accuracy, latency & heterogeneity



Concurrently Enabled

Challenges of AI Applications









AI Hardware



Vision: Drive Leadership Capability Across All Markets

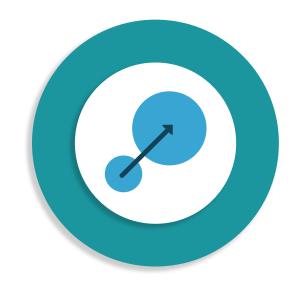


Performance



Invest in performance (Inf/Sec) and Power efficiency (Inf/Sec/W)

Scalability



Leverage existing AI HW engines to scale across various TDP points

Innovation



Feature innovation to drive leadership (Datatypes, Sparsity, Streaming...)

Co-Design



HW & SW co-design to make programmability easier (NAS, Compatibility)



7th Generation : Introducing Qualcomm AI Engine for All Verticals





Qualcomm Technologies, Inc.

7th Generation: Qualcomm AI Engine





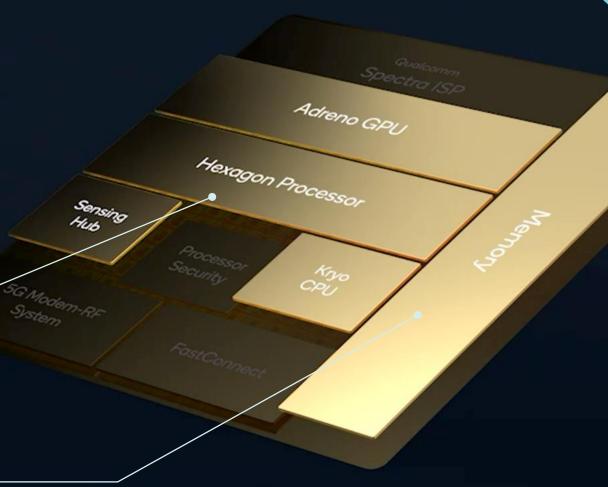
2X

Computational performance

2X

Large-shared memory

Qualcomm



Scaling — Dedicated Investments in AI HW Engines





Using Mobile Design as an Anchor Point



Investment in sparsity modules for supporting Auto ADAS usages



Optimize design for sustained low power with the ability to enable high concurrency



Investment in dedicated datatypes for higher performance and TCO (Total Cost of Ownership)

Performance Leadership — Using MLPerf ™ 2.0



Qualcomm® 8C GEN 1 Mobile



Xiaomi Mi12 Platform

Scaling from Mobile to Cloud..

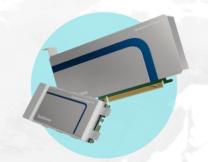
RESNET50
2221
Inf/sec

MOSAIC 752 Inf/sec

BERT
101
Inf/sec

8C GEN 1 achieves an average of about 26% better latency than Exynos devices across various categories

Qualcomm® Cloud AI 100



75W cardsin one server

371,473 Inf/sec

RESNETSO

20 server units in one server rack

7.4+M Inf/sec



Gigabyte Platform

Cloud AI 100 servers achieve 3.7x higher rack-level ResNet-50 inference performance than Nvidia A100 servers

AI Software



Vision: Accelerate AI Innovation and Solution Deployment



Performance



Accelerate "out of box" operator functionality and performance

Scalability



Ability to have programming consistency from Cloud to Edge

Tools



Accelerate Al
Solution deployment
with investment in Tools

Innovation

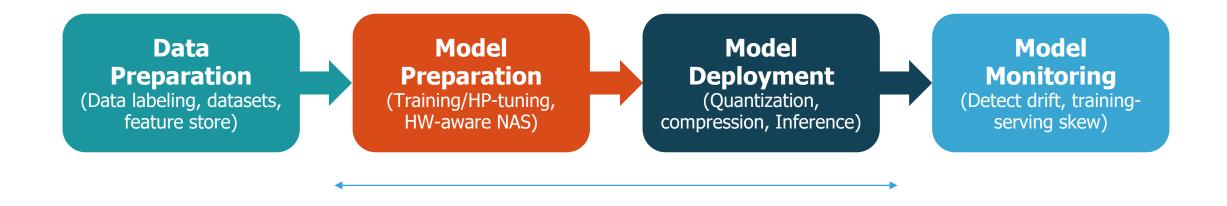


Innovation to drive product leadership (Pre-emption, DFS, Multi Chaining)



Qualcomm AI SW MLOps Cycle (Inception to Monitoring)

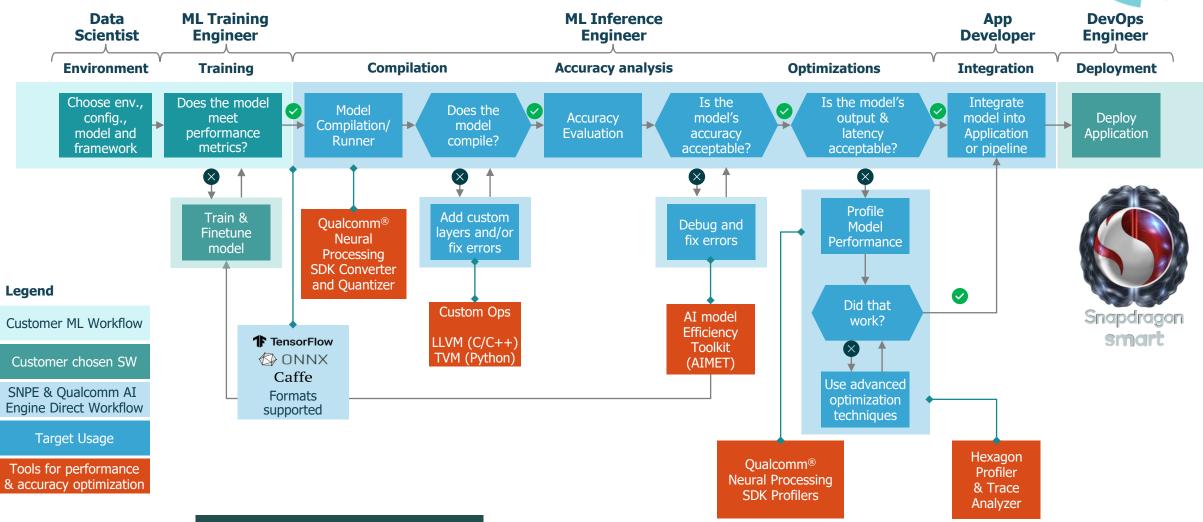




Focus for SW Discussion Today

AI Software Workflow





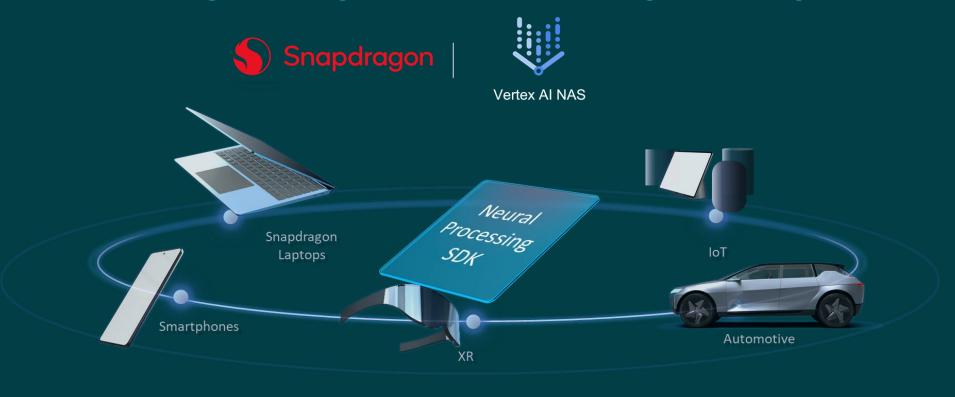
Qualcom

Qualcomm Neural Processing SDK and Qualcomm Al Engine direct are products of Qualcomm Technologies, Inc. and/or its subsidiaries.

STEP: 1 NAS: Model Optimization Mapped to HW Intrinsics



Partnering with Google Vertex AI Team - Integrated into Qualcomm Software Stack



Results →

- 8-10 % Accuracy Improvements
- ~20 to 30% Latency Reduction

Note: DL architecture choices influence results

How >

Search Space

Space of allowable architectures (Structure, operations, connectivity)

Search Algorithm

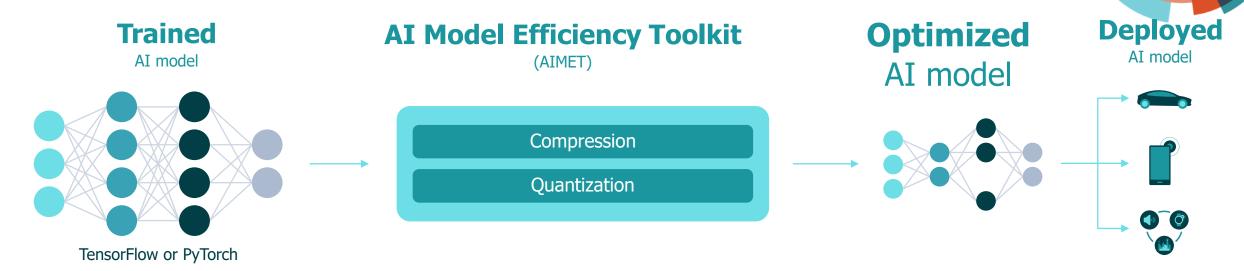
Sampling populations of good architecture candidates

Evaluation Strategy

Estimate performance of sampled architecture

STEP: 2 AIMET: Quantize & Compress AI Models



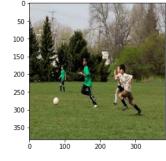


Why →

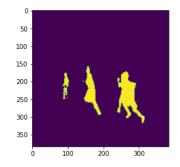
Automated way of enabling reduction in precision of weights and activation while maintaining accuracy

State of the art network compression and quantization tools for various DL architectures (CNN, BERT, GAN's...)

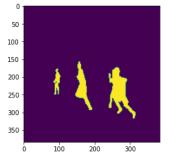
Results →



Original Image



FP16 Segmented Map



Quantized Segmented Map

0.5% Drop in Accuracy (Across various I

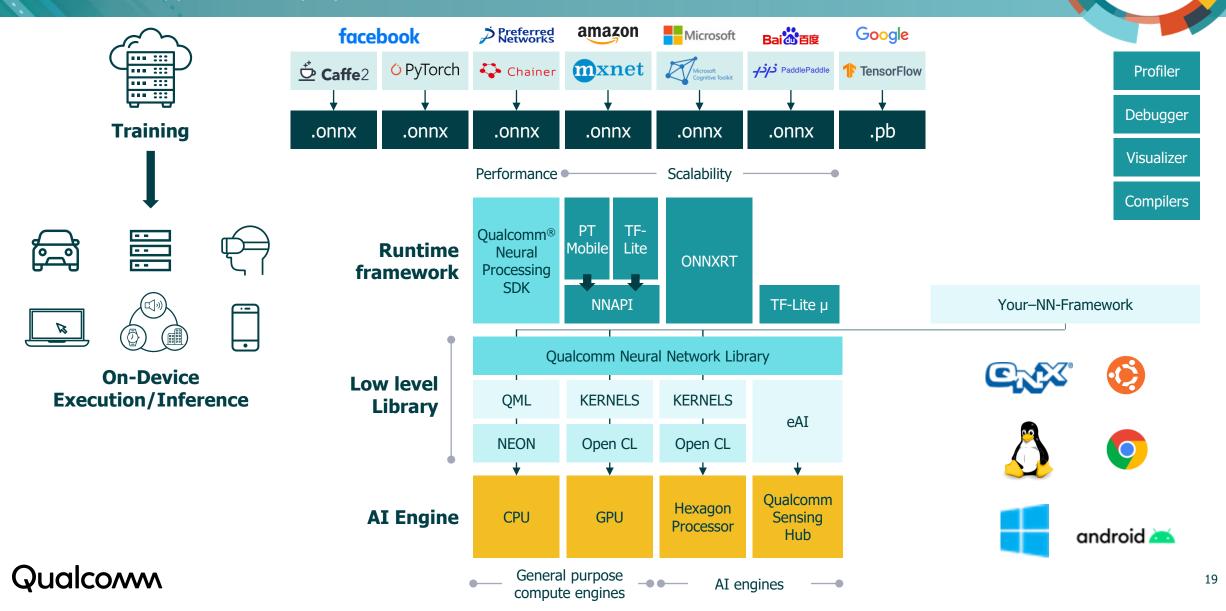
<0.5% Drop in Accuracy (Across various DL Models)
-> Using QAT and PTQ techniques from AIMET

Qualcom

Run Time: Qualcomm AI Software Stack for STEP: 3 Performance and Scalability Support

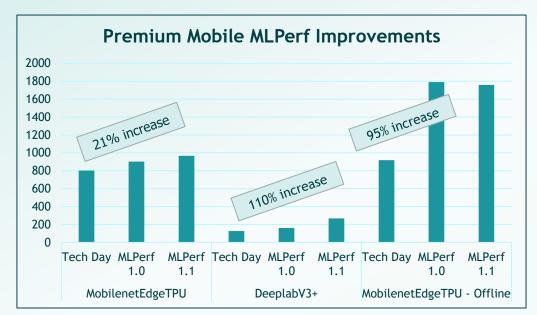
embedded VISION summit

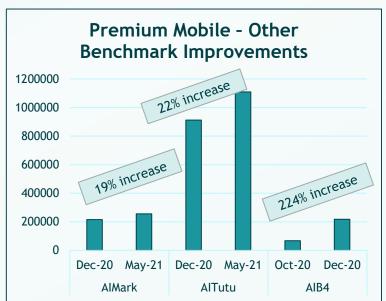
- Application Deployment

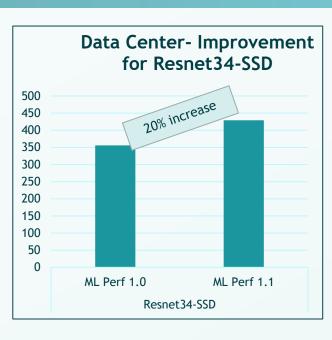


STEP: 4 Continuous Improvements in SW Stack

- For Performance Leadership







- Meaningful improvements after initial chip shipment; achieved through software investment / innovation
- · Consequences -
 - Additional gains across the entire SoC portfolio for downstream chips and adjacent BUs from a common investment
 - Platform software that can be delivered incrementally to already released products can continue to improve
 - Improvements directly leveraged into next generation chips
 - Improvements in current generation can lead to relative performance gap compression with next-gen devices



Conclusions



Snapdragon smart

Conclusion



- AI Applications expanding beyond modalities of computer vision to linguistics, communication,
 commerce and language understanding
- With evolution of AI Applications across many verticals, continued push for innovation around latency, heterogeneity, concurrency and user personalization
 - This is putting a lot of emphasis for the need of custom HW modules in several BU verticals in Qualcomm
- Qualcomm silicon continues to show leadership in performance and energy efficiency in industry leading benchmarks
- High investment in software continues to accelerate AI solution deployment across all verticals

Resources



Qualcomm Mobile AI

Mobile AI | On-Device AI | Qualcomm®

Qualcomm & Google NAS

Qualcomm Technologies and Google Cloud
Announce Collaboration on Neural Architecture
Search for the Connected Intelligent Edge |
Qualcomm

Vinesh Sukumar Senior Director, Product Management – AI/ML vinesuku@qti.qualcomm.com

2022 Embedded Vision Summit

- "Powering the Intelligent Connected Edge and the Future of On-Device AI" Ziad Asghar May 18 9:30
 - 10:00 AM PT
- "A Practical Guide to Getting the DNN Accuracy You Need and the Performance You Deserve" Felix
 Baum May 18 2:40 - 3:10 PM PT
- "Tools for Creating Next-Gen Computer Vision Apps on Snapdragon" Judd Heape May 18 10:50 -11:20 AM PT
- "Seamless Deployment of Multimedia and Machine Learning Applications at the Edge" Megha Daga May 17 2:40 - 3:10 PM PT



